

#### **Maximum Ratings and Thermal Characteristics** ( $T_A = 25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	40	V
Maximum Rms Voltage	V <sub>RMS</sub>	28	V
Maximum Dc Blocking Voltage	V <sub>DC</sub>	40	V
Maximum Average Forward Current	I <sub>F(AV)</sub>	3	А
Peak Forward Surge Current : 8.3ms Single Half Sine- Wave Superimposed On Rated Load	I <sub>FSM</sub>	80	А
Maximum Junction Capacitance Measured at 1 MHZ And Applied $V_R = 4 V$	CJ	160	pF
Typical Thermal Resistance	${\sf R}_{ extsf{ heta}JA}^{(1)}$ ${\sf R}_{ extsf{ heta}JC}^{(2)}$	150 20	°C/W
Operating Junction Temperature Range	TJ	-55~150	°C
Storage Temperature Range	T <sub>STG</sub>	-55~150	°C



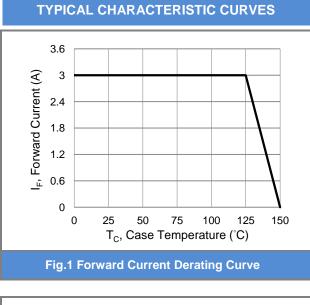


#### **Electrical Characteristics** ( $T_A = 25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Forward Voltage	V <sub>F</sub>	$I_F = 1 \text{ A}, \text{ T}_J = 25 ^{\circ}\text{C}$	-	0.39	-	V	
		$I_F = 3 \text{ A}, \text{ T}_J = 25 ^{\circ}\text{C}$	-	-	0.5		
		$I_F = 1 \text{ A}, \text{ T}_J = 125 ^{\circ}\text{C}$	-	0.28	-		
		$I_F = 3 \text{ A}, \text{ T}_J = 125 ^{\circ}\text{C}$	-	0.42	-		
Reverse Current	I <sub>R</sub> <sup>(3)</sup>	$V_{R} = 32 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$	-	12	-	•	
		$V_{R} = 40 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$	-	-	200	uA	
		$V_{R} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	9	-	mA	

NOTES:

- 1. Mounted on a FR4 PCB, single-sided copper, mini pad.
- 2. Mounted on a FR4 PCB, single-sided copper, with 100cm<sup>2</sup> copper pad area.
- 3. Short duration pulse test used to minimize self-heating effect.



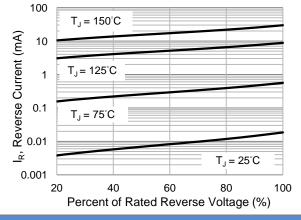
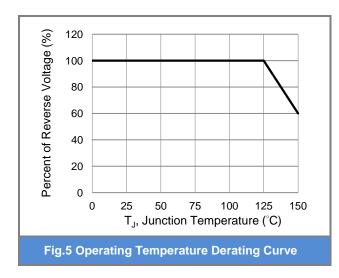


Fig.3 Typical Reverse Characteristics



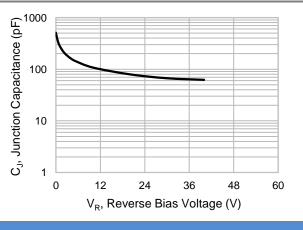


Fig.2 Typical Junction Capacitance

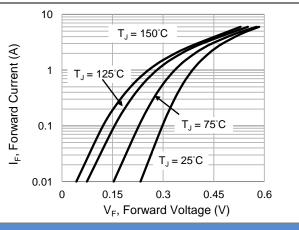


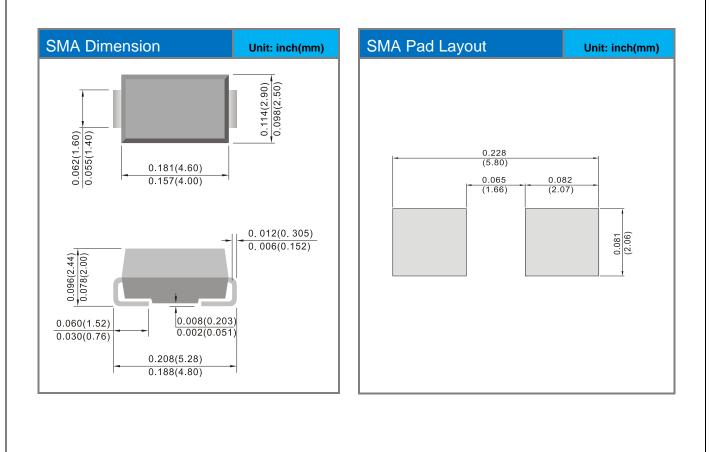
Fig.4 Typical Forward Characteristics



#### Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Marking	Version
SX34-AU_R2_000A1	SMA	7.5K pcs / 13" reel	SX34	Halogen free

#### Packaging Information & Mounting Pad Layout





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